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10/711,882	10/12/2004	Chen-Hsiung Yang	TMIP0001USA	5881
27765 7590 04/13/2007 NORTH AMERICA INTELLECTUAL PROPERTY CORPORATION P.O. BOX 506 MERRIFIELD, VA 22116			EXAMINER	
			GUTIERREZ, KEVIN C	
			ART UNIT	PAPER NUMBER
			2851	
SHORTENED STATUTOR	Y PERIOD OF RESPONSE	NOTIFICATION DATE	DELIVERY MODE	
3 MO	NTHS	04/13/2007	ELECTRONIC	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

Notice of this Office communication was sent electronically on the above-indicated "Notification Date" and has a shortened statutory period for reply of 3 MONTHS from 04/13/2007.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

winstonhsu.uspto@gmail.com Patent.admin.uspto.Rcv@naipo.com mis.ap.uspto@naipo.com.tw Application/Control Number: 10/711,882

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DETAILED ACTION

Response to Arguments

1. Applicant's arguments filed December 28, 2006 have been fully considered but they are not persuasive.

In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See In re Fine, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988) and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, a more secured support would be provided. Further, on pages 6-8 of the Remarks, the Applicant argues there is no suggestion or motivation to make the modification of using a bonding layer to bond the wafer and the membrane goes against Ledger's intended purpose because there is no longer gap between the wafer and the bonding The Examiner respectfully disagrees. With the combination of the chuck carrier structure disclose by Ledger and the bonding layer of Strasbaugh et al., a gap would still exist between the wafer and the membrane, which does not teach away from the intention of Ledger.

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Claim Rejections - 35 USC § 103

2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1-3, 6-8, 10-14, 16-18 and 20-21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ledger et al. (5,515,167) in view of Strasbaugh et al. (US 2003/0134578).

Regarding claims 1, 6, 12 and 16, Ledger et al. discloses "a transparent base (fig. 3, 34; membrane, col. 5, lines 42-44);

- a conducting layer (32; conducting film) positioned on a bottom surface of the transparent base (see figure 3, where conducting layer 32 is located beneath transparent base 32);
- wherein the wafer carrier is attracted by an electrostatic chuck (24) via the conducting layer (col. 5, lines 5-7)."

Ledger et al. does not disclose a (claims 1 and 12) "bonding layer positioned on a top surface of the wafer carrier for bonding the wafer and the transparent base together" and (claims 6 and 16) "wherein the bonding layer is selected from the group consisting of double-sided tape, ultra violet tape, thermal sensitive tape, photo resist, and wax."

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However, having a bonding layer of double-sided tape, ultra violet tape, thermal sensitive tape, photo resist, or wax which bonds the wafer and the transparent layer is known to the art as it is evident by the teaching of Strasbaugh et al. (see claim 3). Thus, it would have been obvious to one ordinary skilled in the art at the time the invention was made to modify the chuck Ledger et al. by including a tape bonding layer utilized in a manner described above for at least the purpose to provide a secure support.

Regarding claim 2, Ledger et al. further disclose "wherein the transparent base has dimensions similar to that of the wafer (col. 5, lines 49-51)."

Regarding claim 3, Ledger et al. further disclose "wherein the transparent base is a glass wafer (col. 5, lines 42-44)."

Regarding claim 7, Ledger et al. further disclose "wherein the wafer is transferred and undergoes at least a semiconductor process (col. 8, lines 62-65)."

Regarding claims 8 and 17-18, Ledger et al. further discloses a semiconductor process (col. 8, lines 62-65) and an alignment mark system (col. 7, lines 1-4). Ledger et al. does not disclose "wherein the semiconductor process is a double-sided process."

However, it would be obvious to one ordinary skilled in the art that the invention of Ledger et al. is capable to perform a double-sided semiconductor process. Ledger et al. teaches where the apparatus can repeatedly perform patterning procedures (col. 8, lines 62-65). Thus, it would have been obvious to one ordinary skilled in the art at the time the invention was made to further modify the

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semiconductor process of Ledger et al. as modified by implementing a double-sided semiconductor process for at least the purpose of reducing cost production.

Regarding claims 10 and 20, Ledger et al. further disclose "wherein the conducting layer is a non-transparent conducting layer (32) having at least an exposed region corresponding to the alignment mark (col. 7, lines 1-4).

Regarding claim 11, Ledger et al. further disclose "wherein the non-transparent conducting layer comprises a plurality of conducting patterns connected with each other (col. 5, lines 32-38)."

Regarding claim 13, Ledger et al. further disclose "wherein the transparent base has dimensions similar to that of the wafer (col. 5, lines 49-51)."

Regarding claim 14, Ledger et al. further disclose "wherein the transparent base is a glass wafer (col. 5, lines 42-44)."

Regarding claim 21, Ledger et al. further disclose "wherein the non-transparent conducting layer comprises a plurality of conducting patterns connected with each other (col. 5, lines 32-38)."

4. Claims 4 and 15 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ledger et al. in view of Strasbaugh et al., as applied to claims 1 and 12, and in further view of Suzuki et al. (US 2003/0029565).

Ledger et al. disclose a transparent base, but does not disclose "wherein the transparent base is a quartz wafer."

However, having a quartz wafer as a transparent base is known to the art as it is evident by the teaching of Suzuki et al. ([0051], lines 2-3). Thus, it would have been obvious to one ordinary skilled in the art at the time the invention was made to modify the transparent base of Ledger et al. by having the transparent base as a quartz wafer for at least the purpose of having a stronger base.

5. Claims 9 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ledger et al. in view of Strasbaugh et al., as applied to claim 8, and in further view of Bollen et al. (4,766,515).

Ledger et al. further disclose a conducting layer, but does not disclose "wherein the conducting layer is a transparent conducting layer."

However, having a transparent conducting layer is known to the art as it is evident by the teaching of Bollen et al. (col. 3, lines 13-15). Thus, it would have been obvious to one ordinary skilled in the art at the time the invention was made to further modify the conductor layers of Ledger et al. as modified by having them as transparent conducting layers for at least the purpose of reducing the weight composition of the chuck.

Conclusion

6. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

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A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a), will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kevin Gutierrez whose telephone number is (571)-272-5922. The examiner can normally be reached on Monday-Friday: 8:00 a.m. - 5:30 p.m.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Diane Lee can be reached on (571)-272-2399. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Kevin Gutierrez Examiner Art Unit 2851

March 28, 2007

DIANE LEE
SUPERVISORY PATENT EXAMINER